

AO3404A

N-Channel Enhancement Mode Field Effect Transistor



General Description

The AO3404A/L uses advanced trench technology to provide excellent $R_{\rm DS(ON)}$ and low gate charge. This device is suitable for use as a load switch or in PWM applications. The source leads are separated to allow a Kelvin connection to the source, which may be used to bypass the source inductance AO3404A and AO3404AL are electrically identical.

- -RoHS Compliant
- -AO3404AL is Halogen Free

Features

 $V_{DS}(V) = 30V$

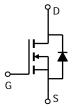
 $I_D = 5.8A$ $(V_{GS} = 10V)$

 $R_{DS(ON)}$ < 28m Ω (V_{GS} = 10V)

 $R_{DS(ON)} < 42m\Omega$ (V_{GS} = 4.5V)

Rg,Ciss,Coss,Crss Tested





Absolute Maximum Ratings T _A =25°C unless otherwise noted									
Parameter		Symbol	Maximum	Units					
Drain-Source Voltage		V_{DS}	30	V					
Gate-Source Voltage		V_{GS}	±20	V					
Continuous Drain	T _A =25°C		5.8						
Current A,F	T _A =70°C	I_D	4.9	Α					
Pulsed Drain Current ^B		I_{DM}	30						
	T _A =25°C	P_{D}	1.4	W					
Power Dissipation	T _A =70°C]' D	0.9	VV					
Junction and Storage Temperature Range		T_J , T_{STG}	-55 to 150	°C					

Thermal Characteristics									
Parameter	Symbol	Тур	Max	Units					
Maximum Junction-to-Ambient ^A	t ≤ 10s	$R_{ heta JA}$	65	90	°C/W				
Maximum Junction-to-Ambient ^A	Steady-State	teady-State		125	°C/W				
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	43	80	°C/W				

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC F	PARAMETERS					
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V			1	μА
	Zero Gate Veltage Brain Garrent	T _J =55°C			5	
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±20V			100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=250\mu A$	1	1.6	3	V
$I_{D(ON)}$	On state drain current	V_{GS} =4.5V, V_{DS} =5V	30			Α
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =5.8A		23.4	28	mΩ
		T _J =125°C		33	40	1115.2
		V _{GS} =4.5V, I _D =4.8A		33.5	42	mΩ
g _{FS}	Forward Transconductance	VDS=5V, ID=5.8A		20		S
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V		0.75	1	V
I _S	Maximum Body-Diode Continuous Curre			1.8	Α	
DYNAMIC	PARAMETERS					
C _{iss}	Input Capacitance			621	820	pF
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =15V, f=1MHz		118		pF
C_{rss}	Reverse Transfer Capacitance			85		pF
R_g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz		0.8	1.5	Ω
SWITCHI	NG PARAMETERS					
Q _g (10V)	Total Gate Charge			11.3	17	nC
Q _g (4.5V)	Total Gate Charge	VCS-10V VDS-15V ID-5 9A		5.7		nC
Q_{gs}	Gate Source Charge	VGS=10V, VDS=15V, ID=5.8A		2.1		nC
Q_{gd}	Gate Drain Charge			3		nC
t _{D(on)}	Turn-On DelayTime			4.5	6.5	ns
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =15V, R_L =2.6 Ω ,		3.1		ns
t _{D(off)}	Turn-Off DelayTime	R_{GEN} =3 Ω		15.1		ns
t _f	Turn-Off Fall Time			2.7		ns
t _{rr}	Body Diode Reverse Recovery Time	IF=5.8A, dI/dt=100A/ms		15.5	21	ns
Q _{rr}	Body Diode Reverse Recovery Charge	IF=5.8A, dI/dt=100A/ms		7.1		nC

A: The value of R_{0JA} is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design. The current rating is based on the $t \leq 10$ s thermal resistance rating.

Rev0: Nov. 2006

Rev1. May.2008

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B: Repetitive rating, pulse width limited by junction temperature.

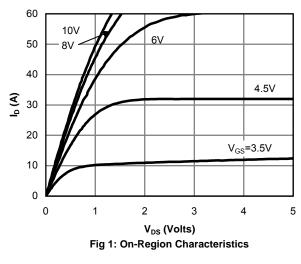
C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The SOA curve provides a single pulse rating.

F.The current rating is based on the \bowtie 10s thermal resistance rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



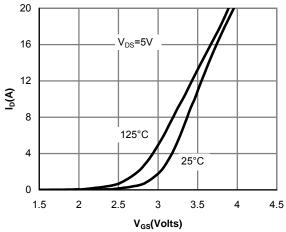


Figure 2: Transfer Characteristics

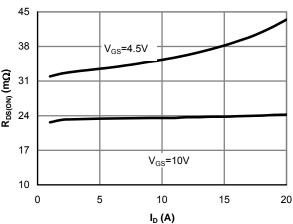


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

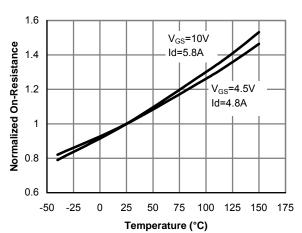


Figure 4: On-Resistance vs. Junction Temperature

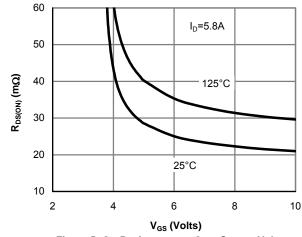


Figure 5: On-Resistance vs. Gate-Source Voltage

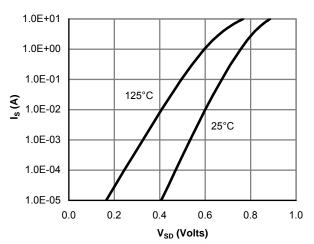


Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

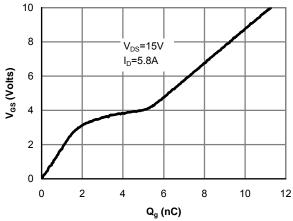


Figure 7: Gate-Charge Characteristics

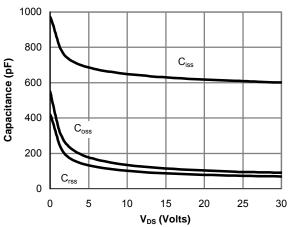


Figure 8: Capacitance Characteristics

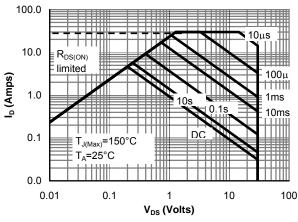


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

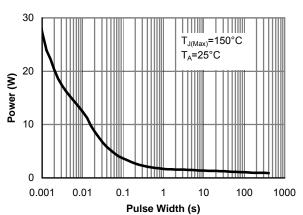


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

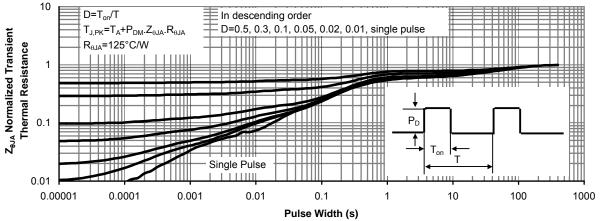


Figure 11: Normalized Maximum Transient Thermal Impedance